# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







### **General Description**

The MAX8730 highly integrated, multichemistry, batterycharger control IC simplifies construction of accurate and efficient chargers. The MAX8730 operates at high switching frequency to minimize external component size and cost. The MAX8730 uses analog inputs to control charge current and voltage, and can be programmed by a microcontroller or hardwired.

The MAX8730 reduces charge current to give priority to the system load, effectively limiting the adapter current and reducing the adapter current requirements.

The MAX8730 provides a digital output that indicates the presence of an AC adapter, and an analog output that monitors the current drawn from the AC adapter. Based on the presence and absence of the AC adapter, the MAX8730 automatically selects the appropriate source for supplying power to the system by controlling two external switches. Under system control, the MAX8730 allows the battery to undergo a relearning cycle in which the battery is completely discharged through the system load and then recharged.

An analog output indicates adapter current or batterydischarge current. The MAX8730 provides a low-quiescent-current linear regulator, which may be used when the adapter is absent, or disabled for reduced current consumption

The MAX8730 is available in a small, 5mm x 5mm, 28pin, thin (0.8mm) QFN package. An evaluation kit is available to reduce design time. The MAX8730 is available in a lead-free package.

### Applications

Notebook Computers Tablet PCs

Pin Configuration appears at end of data sheet.

Portable Equipment with Rechargeable Batteries

### \_\_\_\_\_ Features

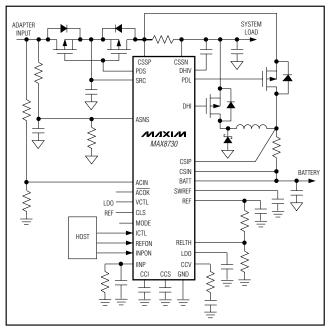
- Small Inductor (3.5µH)
- Programmable Charge Current > 4.5A
- Automatic Power-Source Selection
- Analog Inputs Control Charge Current and Charge Voltage
- Monitor Outputs for AC Adapter Current Battery-Discharge Current AC Adapter Presence
- Independent 3.3V 20mA Linear Regulator
- Up to 17.6V (max) Battery Voltage
- ♦ +8V to +28V Input Voltage Range
- ♦ Reverse Adapter Protection
- System Short-Circuit Protection
- ♦ Cycle-by-Cycle Current Limit

### Ordering Information

PART	TEMP	PIN-	PKG
	RANGE	PACKAGE	CODE
MAX8730ETI+	-40°C to +85°C	28 Thin QFN (5mm x 5mm)	T2855-5

+Denotes lead-free package.

### **Typical Operating Circuit**



### 

Maxim Integrated Products 1

For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

### **ABSOLUTE MAXIMUM RATINGS**

CSSP. SRC. ACOK. ASNS. DHIV. BATT.

	.,
CSIP to GND	0.3V to +30V
CSIP to CSIN or CSSP to CSSN	0.3V to +0.3V
DHIV to SRC	6V to (SRC + 0.3V)
DHI to DHIV	0.3V to (SRC + 0.3V)
PDL, PDS to GND	0.3V to (SRC + 0.3)
CCI, CCS, CCV, IINP, SWREF, REF,	
MODE, ACIN to GND	0.3V to (LDO + 0.3V)

RELTH, VCTL, ICTL, REFON, CLS, LDO,
INPON to GND0.3V to +6V
LDO Short-Circuit Current
Continuous Power Dissipation ( $T_A = +70^{\circ}C$ )
28-Pin TQFN (derate 20.8mW/°C above +70°C)1667mW
Operating Temperature Range40°C to +85°C
Junction Temperature+150°C
Storage Temperature Range60°C to +150°C
Lead Temperature (soldering, 10s)+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **ELECTRICAL CHARACTERISTICS**

(Circuit of Figure 1. V<sub>SRC</sub> = V<sub>ASNS</sub> = V<sub>CSSP</sub> = V<sub>CSSP</sub> = 18V, V<sub>BATT</sub> = V<sub>CSIP</sub> = V<sub>CSIP</sub> = 12V, V<sub>VCTL</sub> = V<sub>ICTL</sub> = 1.8V, MODE = float, ACIN = 0, CLS = REF, REFON = LDO, INPON = LDO, RELTH = 2V. **T<sub>A</sub>** = 0°C to +85°C, unless otherwise noted. Typical values are at T<sub>A</sub> = +25°C.)

PARAMETER	SYMBOL		MIN	ТҮР	MAX	UNITS	
CHARGE-VOLTAGE REGULATIO	N			•			
VCTL Range				0		3.6	V
		V <sub>VCTL</sub> = 3.6V	Not including resistor tolerances	-1.0		+1.0	
Battery-Regulation Voltage Accuracy		or OV	Including 1% resistor tolerances	-1.05		+1.05	%
		V <sub>VCTL</sub> = V <sub>LDO</sub>	(3 or 4 cells)	-0.5		+0.5	
V <sub>VCTL</sub> Default Threshold		V <sub>VCTL</sub> rising		4.4			V
		V <sub>VCTL</sub> = 3V		0		4	
VCTL Input Bias Current			SRC = BATT, ASNS = GND INPON = REFON = 0, V <sub>VCTL</sub> = 5V			16	μA
CHARGE-CURRENT REGULATIO	N						
ICTL Range				0		3.6	V
				128.25	135	141.75	mV
Full-Charge-Current Accuracy		$V_{ICTL} = 3.6V$		-5		+5	%
(CSIP to CSIN)		VICTI = 2.0V		71.25	75	78.75	mV
		VICIL = 2.0V		-5		+5	%
Trickle-Charge-Current Accuracy		$V_{ICTL} = 120mV$		2.5	4.5	7.5	mV
Charge-Current Gain Error		Based on VICTI	$_{-}$ = 3.6V and V <sub>ICTL</sub> = 0.12V	-1.9		+1.9	%
Charge-Current Offset Error		Based on VICTI	$_{-}$ = 3.6V and V <sub>ICTL</sub> = 0.12V	-2		+2	mV
BATT/CSIP/CSIN Input Voltage Range				0		19	V
		Charging enab	Charging enabled		300	600	
CSIP/CSIN Input Current		Charging disat ASNS = GND c	oled, SRC = BATT, or V <sub>ICTL</sub> = 0V		8	16	μA

### **ELECTRICAL CHARACTERISTICS (continued)**

(Circuit of Figure 1.  $V_{SRC} = V_{ASNS} = V_{CSSP} = V_{CSSN} = 18V$ ,  $V_{BATT} = V_{CSIP} = V_{CSIN} = 12V$ ,  $V_{VCTL} = V_{ICTL} = 1.8V$ , MODE = float, ACIN = 0, CLS = REF, REFON = LDO, INPON = LDO, RELTH = 2V. **TA = 0°C to +85°C**, unless otherwise noted. Typical values are at TA = +25°C.)

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS
ICTL Power-Down Mode		ICTL falling	50	65	80	
Threshold		$\begin{array}{c c c c c c c c } & ICTL falling & 50 \\ \hline ICTL rising & 70 \\ \hline V_{ICTL} = 3V & -1 \\ SRC = BATT, ASNS = GND, V_{ICTL} = 5V & -1 \\ \hline SRC = BATT, ASNS = GND, V_{ICTL} = 5V & -1 \\ \hline 72.7 \\ \hline V_{CLS} = REF (trim point) & 72.7 \\ \hline -4 \\ \hline V_{CLS} = REF x 0.7 & 50 \\ \hline -5.6 \\ \hline V_{CLS} = REF x 0.7 & -5 \\ \hline 0.6 \\ \hline V_{CLS} = REF x 0.5 & -6.6 \\ \hline 8.00 \\ \hline V_{CSSP} = V_{CSSN} = V_{SRC} > 8.0V & -7 \\ \hline V_{CLS} = 2.0V & -1 \\ \hline V_{CSSP} - V_{CSSN} = 56mV & 2.66 \\ \hline V_{CSSP} - V_{CSSN} = 75mV & -8 \\ \hline V_{CSSP} - V_{CSSN} = 56mV & -5 \\ \hline \end{array}$	70	90	110	mV
		V <sub>ICTL</sub> = 3V	-1		+1	
ICTL Input Bias Current		FL fallingft fallingFL rising7 $C = BATT, ASNS = GND, V_{ICTL} = 5V$ 72 $C = BATT, ASNS = GND, V_{ICTL} = 5V$ 72 $LS = REF (trim point)$ 72 $LS = REF x 0.7$ 6 $LS = REF x 0.5$ 72 $LS = REF x 0.5$ 74 $LS = REF x 0.5$ 74 $LS = 2.0V$ 74 $RC = 0V$ 1 $LS = 2.0V$ 75 $SSP - VCSSN = 56mV$ 75 $SSP - VCSSN = 75mV$ 75 $SSP - VCSSN = 56mV$ 75 $SSP - VCSSN = 56mV$ 75 $SSP - VCSSN = 20mV$ 71 $Sed on V_{ICTL} = REF x 0.5 and V_{ICTL} = REF$ 72 $Sed on V_{ICTL} = REF x 0.5 and V_{ICTL} = REF$ 73	-1		+1	μA
CSSP-to-CSSN Full-Scale Current-Sense Voltage			72.75	75.75	78.75	mV
			72.75	75.75	78.75	mV
		$V_{CLS} = REF (trim point)$	-4		+4	%
Incut Current Limit Accuracy			50	53	56	mV
Input Current-Limit Accuracy		$VCLS = REF \times 0.7$	-5.6		+5.6	%
			36	38	40.5	mV
		VCLS = HEF X 0.5	-6.6		+6.6	%
CSSP/CSSN Input Voltage Range			8.0		28	V
CSSP/CSSN Input Current		$V_{CSSP} = V_{CSSN} = V_{SRC} > 8.0V$		400	800	
CSSF/CSSN input Current		V <sub>SRC</sub> = 0V		0.1	1	μA
CLS Input Range			1.1		REF	V
CLS Input Bias Current		$V_{CLS} = 2.0V$	-1		+1	μA
IINP Transconductance		V <sub>CSSP</sub> - V <sub>CSSN</sub> = 56mV	2.66	2.8	2.94	µA/mV
		$V_{CSSP}$ - $V_{CSSN}$ = 100mV, $V_{IINP}$ = 0 to 4.5V	-5		+5	
IINP Accuracy		$V_{CSSP} - V_{CSSN} = 75 mV$	-8		+8	%
INF Accuracy		V <sub>CSSP</sub> - V <sub>CSSN</sub> = 56mV	-5		+5	/0
		$V_{CSSP} - V_{CSSN} = 20 mV$	-12.5		+12.5	
IINP Gain Error		Based on $V_{ICTL} = REF \times 0.5$ and $V_{ICTL} = REF$	-7		+7	%
IINP Offset Error		Based on $V_{ICTL} = REF \times 0.5$ and $V_{ICTL} = REF$	-2		+2	mV
IINP Fault threshold		IINP rising	4.1	4.2	4.3	V
SUPPLY AND LINEAR REGULAT	OR					
SRC Input Voltage Range			8.0		28	V
SRC Undervoltage Lockout		SRC falling	7	7.4		V
Threshold		SRC rising		7.5	8	v

### **ELECTRICAL CHARACTERISTICS (continued)**

(Circuit of Figure 1.  $V_{SRC} = V_{ASNS} = V_{CSSP} = V_{CSSN} = 18V$ ,  $V_{BATT} = V_{CSIP} = V_{CSIN} = 12V$ ,  $V_{VCTL} = V_{ICTL} = 1.8V$ , MODE = float, ACIN = 0, CLS = REF, REFON = LDO, INPON = LDO, RELTH = 2V. **TA = 0°C to +85°C**, unless otherwise noted. Typical values are at TA = +25°C.)

PARAMETER	SYMBOL	CONDITIONS			MIN	TYP	MAX	UNITS
		Normal mode				4	6	mA
			VINPON	=VREFON = low		10	20	
SRC Quiescent Current (INPON/REFON = Don't Care)		VSRC = VBATT =	Vinpon Vrefon			300	600	
		12V, ASNS = GND (Note 2)	Vinpon Vrefon			300	600	μA
			VINPON	= VREFON = high		350	600	
		V <sub>BATT</sub> = 16.8V, V	SRC = 19V	, ICTL = 0		8	16	
BATT Input Current		$V_{BATT} = 2V \text{ to } 19^{V}$	/, V <sub>SRC</sub> >	V <sub>BATT</sub> + 0.3V		300	600	μA
		ICSIP + ICSIN + IB	ATT, ASNS	= GND		2	5	
Battery-Leakage Current		I <sub>CSIP</sub> + I <sub>CSIN</sub> + I <sub>B</sub>		$V_{REFON} = 5.4V$		300	600	μA
		I <sub>CSSP</sub> + I <sub>CSSN</sub> + I ASNS = REFON =		INPON = GND		2	5	
LDO Output Voltage		8.0V < V <sub>SRC</sub> < 28	V, no load		5.2	5.35	5.5	V
LDO Load Regulation		0 < 1LDO < 10mA	L .			20	50	mV
LDO Undervoltage Lockout Threshold		V <sub>SRC</sub> = 8.0V			4		V	
REFERENCES								
REF Output Voltage	Ref			4.18	4.20	4.22	V	
REF Undervoltage Lockout Threshold		REF falling				3.1	3.9	V
SWREF Output Voltage		8.0V < VSRC < 28	3V, no load	b	3.234	3.3	3.366	V
SWREF Load Regulation		0.1mA < ISWREF <				20	50	mV
TRIP POINTS								
ACIN Threshold		ACIN rising			2.037	2.1	2.163	V
ACIN Threshold Hysteresis						60		mV
ACIN Input Bias Current		V <sub>ACIN</sub> = 2.048V			-1		+1	μA
SWITCHING REGULATOR								
DHI Off-Time		$V_{BATT} = 16.0V$			300	350	400	ns
DHI Off-Time K Factor		V <sub>BATT</sub> = 16.0V			4.8	5.6	6.4	V x µs
Sense Voltage for Minimum Discontinuous Mode Ripple Current		VCSIP - VCSIN			7		mV	
Cycle-by-Cycle Current-Limit Sense Voltage					160	200	240	mV
Charge Disable Threshold		V <sub>SRC</sub> - V <sub>BATT</sub> , SR	C falling		40	60	80	mV
DHIV Output Voltage		With respect to SI			-4.3	-4.8	-5.5	V
DHIV Sink Current					10			mA

### **ELECTRICAL CHARACTERISTICS (continued)**

(Circuit of Figure 1.  $V_{SRC} = V_{ASNS} = V_{CSSP} = V_{CSSN} = 18V$ ,  $V_{BATT} = V_{CSIP} = V_{CSIN} = 12V$ ,  $V_{VCTL} = V_{ICTL} = 1.8V$ , MODE = float, ACIN = 0, CLS = REF, REFON = LDO, INPON = LDO, RELTH = 2V. **TA = 0°C to +85°C**, unless otherwise noted. Typical values are at TA = +25°C.)

PARAMETER	SYMBOL	CONDITIO	CONDITIONS		TYP	MAX	UNITS
DHI Resistance Low		I <sub>DHI</sub> = -10mA	I <sub>DHI</sub> = -10mA		2	4	Ω
DHI Resistance High		I <sub>DHI</sub> = 10mA		1	2	Ω	
ERROR AMPLIFIERS		·					
		VCTL = 3.6V, VBATT = 16.8	/, MODE = LDO	0.0625	0.125	0.250	
GMV Loop Transconductance		VCTL = 3.6V, VBATT = 12.6	/, MODE = FLOAT	0.0833	0.167	0.333	mA/V
GMI Loop Transconductance		ICTL = 3.6V, V <sub>CSSP</sub> - V <sub>CSI</sub>	<sub>N</sub> = 75mV	0.5	1	2	mA/V
GMS Loop Transconductance		$V_{CLS} = 2.048V, V_{CSSP} - V_{CSSN} = 75mV$		0.5	1	2	mA/V
CCI/CCS/CCV Clamp Voltage		1.1V < V <sub>CCV</sub> < 3.0V, 1.1V < V <sub>CCI</sub> < 3.0V, 1.1V < V <sub>CCS</sub> < 3.0V		150	300	600	mV
LOGIC LEVELS							
MODE, REFON Input Low Voltage						0.5	V
MODE Input Middle Voltage				1.9	2.65	3.3	V
MODE, REFON Input High Voltage				3.4			V
MODE, REFON, INPON Input Bias Current		MODE = 0 or 3.6V		-2		+2	μA
INDON Threaded		VINPON rising	VINPON rising				V
INPON Threshold		VINPON falling				0.8	V
ADAPTER DETECTION		·					
ACOK Voltage Range				0		28	V
ACOK Sink Current		V <sub>ACOK</sub> = 0.4V, ACIN = 1.5	δV	1			mA
ACOK Leakage Current		$V_{ACOK} = 28V, ACIN = 2.5$	V			1	μΑ
BATTERY DETECTION							
BATT Overvoltage Threshold		V <sub>VCTL</sub> = V <sub>LDO</sub> , BATT rising; result with respect	V <sub>MODE</sub> = V <sub>LDO</sub>		+140		mV
-		to battery-set voltage	$V_{MODE} = FLOAT$		+100		
BATT Overvoltage Hysteresis					100		mV
RELTH Operating Voltage Range				0.9		2.6	V
RELTH Input Bias Current		$V_{RELTH} = 0.9V$ to 2.6V		-50		+50	nA
BATT Minimum Voltage Trip		Vo art folling	$V_{RELTH} = 0.9V$	4.42	4.5	4.58	v
Threshold		V <sub>BATT</sub> falling	$V_{RELTH} = 2.6V$	12.77	13.0	13.23	v
PDS, PDL SWITCH CONTROL							
Adapter-Absence Detect Threshold		VASNS - VBATT, VASNS falling		-300	-280	-240	mV
Adapter-Detect Threshold		VASNS - VBATT		-140	-100	-60	mV
PDS Output Low Voltage		Result with respect to SRC	C, I <sub>PDS</sub> = 0	-8	-10	-12	V
PDS/PDL Output High Voltage		Result with respect to SRC	C, I <sub>PD_</sub> = 0		-0.2	-0.5	V
PDS/PDL Turn-Off Current		VPDS = VSRC - 2V, VSRC =	16V	6	12		mA



### **ELECTRICAL CHARACTERISTICS (continued)**

(Circuit of Figure 1.  $V_{SRC} = V_{ASNS} = V_{CSSP} = V_{CSSN} = 18V$ ,  $V_{BATT} = V_{CSIP} = V_{CSIN} = 12V$ ,  $V_{VCTL} = V_{ICTL} = 1.8V$ , MODE = float, ACIN = 0, CLS = REF, REFON = LDO, INPON = LDO, RELTH = 2V. **TA = 0°C to +85°C**, unless otherwise noted. Typical values are at TA = +25°C.)

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	МАХ	UNITS
PDS Turn-On Current		PDS = SRC	6	12		mA
PDL Turn-On Resistance		PDL = GND	50	100	200	kΩ
PDS/PDL Delay Time				5.0		μs

### **ELECTRICAL CHARACTERISTICS**

(Circuit of Figure 1.  $V_{SRC} = V_{ASNS} = V_{CSSP} = V_{CSSN} = 18V$ ,  $V_{BATT} = V_{CSIP} = V_{CSIN} = 12V$ ,  $V_{VCTL} = V_{ICTL} = 1.8V$ , MODE = float, ACIN = 0, CLS = REF, REFON = LDO, INPON = LDO, RELTH = 2V. **T<sub>A</sub> = -40°C to +85°C**, unless otherwise noted.)

PARAMETER	SYMBOL		MIN	ТҮР	MAX	UNITS	
CHARGE-VOLTAGE REGULATIO	N						
VCTL Range				0		3.6	V
		V <sub>VCTL</sub> = 3.6V	Not including resistor tolerances	-1.2		+1.2	
Battery-Regulation-Voltage Accuracy		or 0V	Including 1% resistor tolerances	-1.25		+1.25	%
		V <sub>VCTL</sub> = V <sub>LDO</sub>	(3 or 4 cells)	-0.8		+0.8	
VVCTL Default Threshold		$V_{VCTL}$ rising		4.4			V
VCTL Input Bias Current			SRC = BATT, ASNS = GND INPON = REFON = 0, V <sub>VCTL</sub> = 5V			16	μA
CHARGE-CURRENT REGULATION	DN						
ICTL Range				0		3.6	V
			128.25		141.75	mV	
Full-Charge-Current Accuracy		$V_{ICTL} = 3.6V$		-5		+5	%
(CSIP to CSIN)			70		80	mV	
		$V_{ICTL} = 2.0V$		-6.7		+6.7	%
Trickle-Charge-Current Accuracy		$V_{ICTL} = 120mV$		2		10	mV
Charge-Current Gain Error		Based on VICTL	$= 3.6V$ and $V_{ICTL} = 0.12V$	-1.9		+1.9	%
Charge-Current Offset Error		Based on VICTL	$= 3.6V$ and $V_{ICTL} = 0.12V$	-2		+2	mV
BATT/CSIP/CSIN Input Voltage Range				0		19	V
		Charging enabl	ed			1000	
CSIP/CSIN Input Current		Charging disab ASNS = GND, c	led, SRC = BATT, pr V <sub>ICTL</sub> = 0V				μA
ICTL Power-Down Mode		ICTL falling		50		80	
Threshold		ICTL rising		70		110	mV

### **ELECTRICAL CHARACTERISTICS (continued)**

(Circuit of Figure 1.  $V_{SRC} = V_{ASNS} = V_{CSSP} = V_{CSSN} = 18V$ ,  $V_{BATT} = V_{CSIP} = V_{CSIN} = 12V$ ,  $V_{VCTL} = V_{ICTL} = 1.8V$ , MODE = float, ACIN = 0, CLS = REF, REFON = LDO, INPON = LDO, RELTH = 2V. **T<sub>A</sub> = -40°C to +85°C**, unless otherwise noted.)

PARAMETER	SYMBOL	C	ONDITIO	NS	MIN	ТҮР	MAX	UNITS
INPUT-CURRENT REGULATION		1						
CSSP-to-CSSN Full-Scale Current-Sense Voltage					72.75		78.25	mV
		V <sub>CLS</sub> = REF (trim	point)		72.75		78.25	mV
Input Current-Limit Accuracy		V <sub>CLS</sub> = REF x 0.7	,		50.0		56.0	mV
		V <sub>CLS</sub> = REF x 0.5	)		36.00		40.50	mV
CSSP/CSSN Input Voltage Range					8.0		28	V
CSSP/CSSN Input Current		V <sub>CSSP</sub> = V <sub>CSSN</sub> =	= V <sub>SRC</sub> >	8.0V			1000	μA
CLS Input Range					1.1		REF	V
IINP Transconductance		V <sub>CSSP</sub> - V <sub>CSSN</sub> =	56mV		2.66		2.94	µA/mV
		V <sub>CSSP</sub> - V <sub>CSSN</sub> =	100mV, \	$V_{\text{IINP}} = 0 \text{ to } 4.5 \text{V}$	-5		+5	
		VCSSP - VCSSN =	75mV		-8		+8	0/
IINP Accuracy		$V_{CSSP} - V_{CSSN} = 56 \text{mV}$		-5		+5	%	
		VCSSP - VCSSN =	20mV		-12.5		+12.5	
IINP Gain Error		Based on VICTL =	= REF x 0.5 and $V_{ICTL}$ = REF		-7		+7	%
IINP Offset Error		Based on VICTL =	REF x 0.5	$\overline{b}$ and $V_{ICTL} = REF$	-2		+2	mV
IINP Fault Threshold		IINP rising			4.1		4.3	V
SUPPLY AND LINEAR REGULAT	OR							
SRC Input Voltage Range					8.0		28	V
SRC Undervoltage Lockout		SRC falling			7			v
Threshold		SRC rising					8	v
		Normal mode					6	mA
			VINPON	= V <sub>REFON</sub> = low			20	
SRC Quiescent Current		SRC = VBATT =	VINPON = low, VREFON = high				600	
(INPON/REFON = Don't Care)		12V, ASNS = GND (Note 2)	Vinpon Vrefon				600	μA
				= VREFON = high			600	
BATT Input Current		VBATT = 2V to 19					600	μA
Battery Leakage Current		ICSIP + ICSIN + IB + ICSSP + ICSSN +	ATT	V <sub>REFON</sub> = 5.4V			600	μA
,		ASNS = REFON		INPON = GND			16	P 1
LDO Output Voltage		8.0V < VSRC < 2	8V, no loa	ad	5.2		5.5	V
LDO Load Regulation		$0 < I_{LDO} < 10 m^{4}$	4				50	mV

### ELECTRICAL CHARACTERISTICS (continued)

(Circuit of Figure 1.  $V_{SRC} = V_{ASNS} = V_{CSSP} = V_{CSSN} = 18V$ ,  $V_{BATT} = V_{CSIP} = V_{CSIN} = 12V$ ,  $V_{VCTL} = V_{ICTL} = 1.8V$ , MODE = float, ACIN = 0, CLS = REF, REFON = LDO, INPON = LDO, RELTH = 2V. **TA = -40°C to +85°C**, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	МАХ	UNITS
REFERENCES	•	·	•			
REF Output Voltage	Ref	0 < IREF < 500μA	4.16		4.24	V
REF Undervoltage Lockout Threshold		REF falling			3.9	V
SWREF Output Voltage		8.0V < VSRC < 28V, no load	3.224		3.376	V
SWREF Load Regulation		0.1mA < ISWREF < 20mA			50	mV
TRIP POINTS	•	·	•			
ACIN Threshold		ACIN rising	2.037		2.163	V
SWITCHING REGULATOR		•				
DHI Off-Time		V <sub>BATT</sub> = 16.0V	300		400	ns
DHI Off-Time K Factor		V <sub>BATT</sub> = 16.0V	4.8		6.4	V x µs
Cycle-by-Cycle Current-Limit Sense Voltage			160		240	mV
DHIV Output Volatge		With respect to SRC	-4.3		-5.5	V
DHIV Sink Current			10			mA
DHI Resistance Low		I <sub>DHI</sub> = -10mA			4	Ω
DHI Resistance High		I <sub>DHI</sub> = 10mA			2	Ω
ERROR AMPLIFIERS						
		VCTL = 3.6V, V <sub>BATT</sub> = 16.8V, MODE = LDO	0.0625		0.250	
GMV Loop Transconductance		VCTL = 3.6V, V <sub>BATT</sub> = 12.6V, MODE = FLOAT	0.0833		0.333	mA/V
GMI Loop Transconductance		$ICTL = 3.6V, V_{CSSP} - V_{CSIN} = 75mV$	0.5		2	mA/V
GMS Loop Transconductance		$V_{CLS} = 2.048V$ , $V_{CSSP} - V_{CSSN} = 75mV$	0.5		2	mA/V
CCI/CCS/CCV Clamp Voltage		1.1V < V <sub>CCV</sub> < 3.0V, 1.1V < V <sub>CCI</sub> < 3.0V, 1.1V < V <sub>CCS</sub> < 3.0V	150		600	mV
LOGIC LEVELS						
MODE, REFON Input Low Voltage					0.5	V
MODE Input Middle Voltage			1.9		3.3	V
MODE, REFON Input High Voltage			3.4			V
INPON Threshold		VINPON rising	2.2			V
		VINPON falling			0.8	v
ADAPTER DETECTION						
ACOK Voltage Range			0		28	V
ACOK Sink Current		V <sub>ACOK</sub> = 0.4V, ACIN = 1.5V	1			mA

### **ELECTRICAL CHARACTERISTICS (continued)**

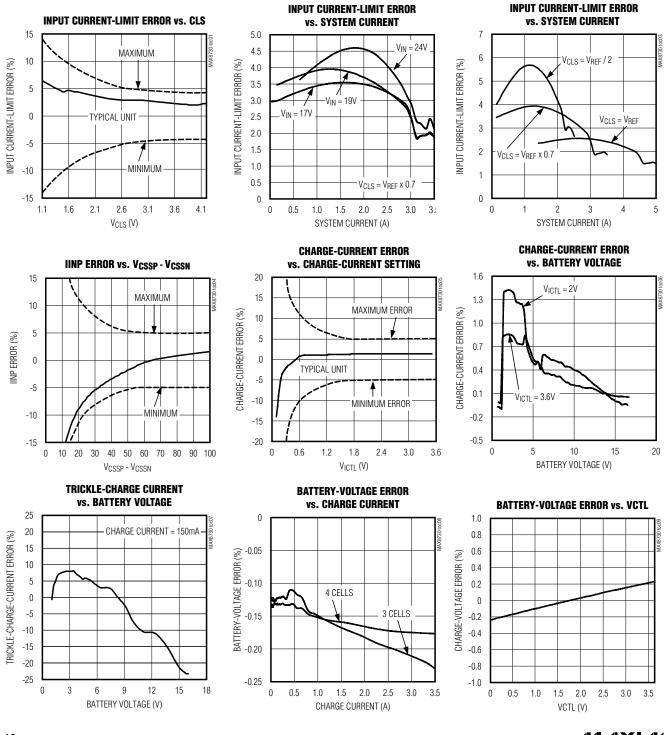
(Circuit of Figure 1. V<sub>SRC</sub> = V<sub>ASNS</sub> = V<sub>CSSP</sub> = V<sub>CSSN</sub> = 18V, V<sub>BATT</sub> = V<sub>CSIP</sub> = V<sub>CSIP</sub> = 12V, V<sub>VCTL</sub> = V<sub>ICTL</sub> = 1.8V, MODE = float, ACIN = 0, CLS = REF, REFON = LDO, INPON = LDO, RELTH = 2V. **T**<sub>A</sub> = -40°C to +85°C, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS		MIN	ТҮР	MAX	UNITS
BATTERY DETECTION		·					
RELTH Operating Voltage Range				0.9		2.6	V
BATT Minimum Voltage Trip		V folling	$V_{RELTH} = 0.9V$	4.42		4.58	V
Threshold		VBATT falling	$V_{RELTH} = 2.6V$	12.77		13.23	v
PDS, PDL SWITCH CONTROL							
Adapter-Absence-Detect Threshold		VASNS - VBATT, VASNS falling		-310		-240	mV
Adapter-Detect Threshold		V <sub>ASNS</sub> - V <sub>BATT</sub>		-140		-60	mV
PDS Output Low Voltage		Result with respect to SRC	$I_{PDS} = 0$	-7		-12	V
PDS/PDL Output High Voltage		Result with respect to SRC	I <sub>PD_</sub> = 0			-0.5	V
PDS/ PDL Turn-Off Current		V <sub>PDS</sub> = V <sub>SRC</sub> - 2V, V <sub>SRC</sub> = 16V		6			mA
PDS Turn-On Current		PDS = SRC		6			mA
PDL Turn-On Resistance		PDL = GND		50	100	200	kΩ

**Note 1:** Accuracy does not include errors due to external-resistance tolerances. **Note 2:** In this mode, SRC current is drawn from the battery.

### **Typical Operating Characteristics**

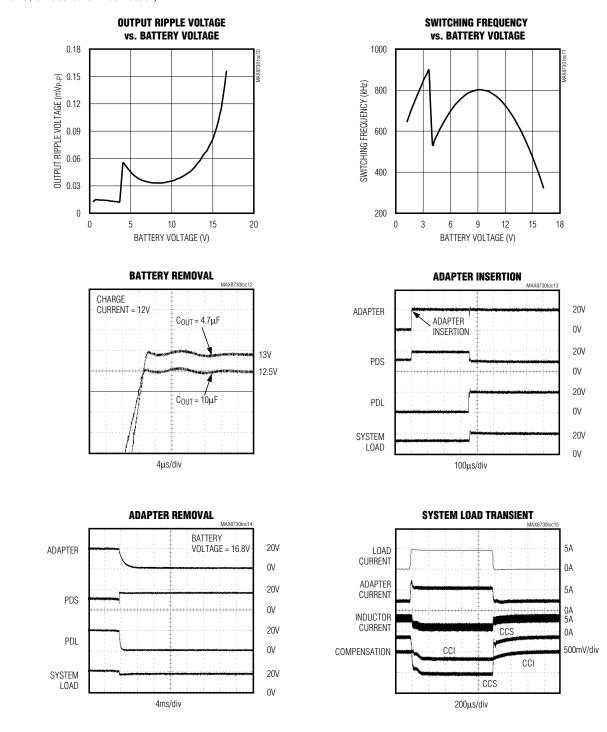
(Circuit of Figure 1, adapter = 19.5V, V<sub>BATT</sub> = 12V, V<sub>ICTL</sub> = 2.4V, MODE > 1.8V, REFON = INPON = LDO, V<sub>RELTH</sub> = V<sub>REF</sub>/2, T<sub>A</sub> = +25°C, unless otherwise noted.)





### **Typical Operating Characteristics (continued)**

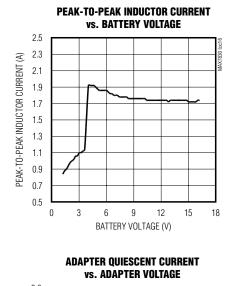
(Circuit of Figure 1, adapter = 19.5V, V<sub>BATT</sub> = 12V, V<sub>ICTL</sub> = 2.4V, MODE > 1.8V, REFON = INPON = LDO, V<sub>RELTH</sub> = V<sub>REF</sub>/2, T<sub>A</sub> = +25°C, unless otherwise noted.)

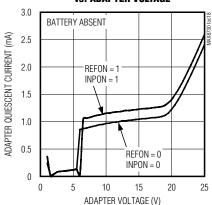


MAX8730

### **Typical Operating Characteristics (continued)**

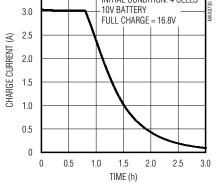
(Circuit of Figure 1, adapter = 19.5V, V<sub>BATT</sub> = 12V, V<sub>ICTL</sub> = 2.4V, MODE > 1.8V, REFON = INPON = LDO, V<sub>RELTH</sub> = V<sub>REF</sub>/2, T<sub>A</sub> = +25°C, unless otherwise noted.)

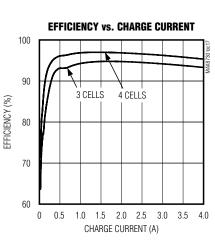




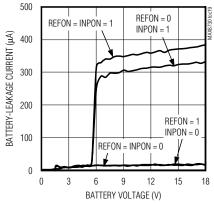


3.5

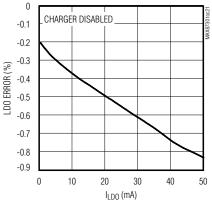




BATTERY LEAKAGE CURRENT vs. Battery Voltage



LDO LOAD REGULATION





CHARGER DISABLED

100

10

200

I<sub>REF</sub> (µA)

**SWREF LOAD REGULATION** 

20

SWREF OUTPUT CURRENT (mA)

**DISCONTINUOUS MODE** SWITCHING WAVEFORM

30

CHARGE CURRENT = 20mA

1µs/div

40

1A

0

20V

0

20V DHI

0

INDUCTOR

CURRENT

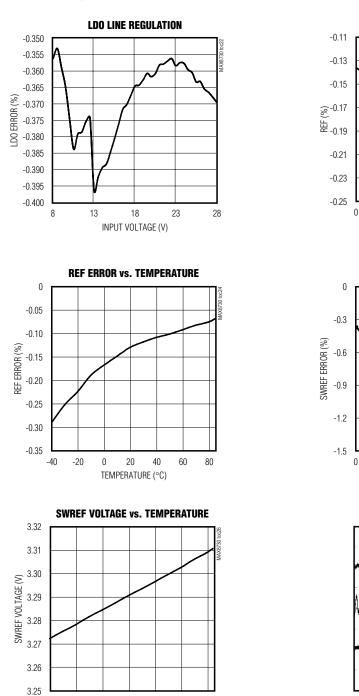
LX

300

400

500

(Circuit of Figure 1, adapter = 19.5V, V<sub>BATT</sub> = 12V, V<sub>ICTL</sub> = 2.4V, MODE > 1.8V, REFON = INPON = LDO, V<sub>RELTH</sub> = V<sub>REF</sub>/2, T<sub>A</sub> = +25°C, unless otherwise noted.)





**MAX8730** 

-40 -20 0 20 40 60 80

TEMPERATURE (°C)

### **Pin Description**

PIN	NAME	FUNCTION					
1	ASNS	Adapter Voltage Sense. When $V_{ASNS} > V_{BATT}$ - 280mV, the battery switch is turned off and the adapter switch is turned on. Connect to the adapter input using an RC filter as shown in Figure 1.					
2	LDO	Linear-Regulator Output. LDO is the output of the 5.35V linear regulator supplied from SRC. Bypass LDO with a $1\mu$ F ceramic capacitor from LDO to GND.					
3	SWREF	3.3V Switched Reference. SWREF is a 1% accurate linear regulator that can deliver 20mA. SWREF remain active when the adapter is absent and may be disabled by setting REFON to zero. Bypass SWREF with a capacitor to GND.					
4	REF	4.2V Voltage Reference. Bypass REF with a 1µF capacitor to GND.					
5	CLS	Source Current-Limit Input. Voltage input for setting the current limit of the input source.					
6	ACIN	AC-Adapter-Detect Input. ACIN is the input to an uncommitted comparator. ACIN does not influence adapter and battery selection.					
7	VCTL	Charge-Voltage-Control Input. Connect VCTL to LDO for default 4.2V/cell.					
8	RELTH	Relearn Threshold for Relearn Mode. In relearn mode, when V <sub>BATT</sub> < 5 x V <sub>RELTH</sub> , the MAX8730 drives PDS low and drives PDL high to terminate relearning of a discharged battery. See the <i>Relearn Mode</i> section for more details.					
9	ACOK	AC Detect Output. This open-drain output pulls low when ACIN is greater than REF/2 and ASNS is greater than BATT - 100mV. The $\overline{\text{ACOK}}$ output is high impedance when the MAX8730 is powered down. Connect a 10k $\Omega$ pullup resistor from LDO to $\overline{\text{ACOK}}$ .					
10	MODE	Tri-Level Input for Setting Number of Cells or Asserting the Conditioning Mode: MODE = GND; asserts relearn mode. MODE = Float; charge with 3 times the cell voltage programmed at VCTL. MODE = LDO; charge with 4 times the cell voltage programmed at VCTL.					
11	IINP	Input-Current-Monitor Output. IINP sources the current proportional to the current sensed across CSSP and CSSN. The transconductance from (CSSP – CSSN) to IINP is 2.8µA/mV (typ).					
12	ICTL	Charge-Current-Control Input. Pull ICTL to GND to shut down the charger.					
13	REFON	SWREF Enable. Drive REFON high to enable SWREF.					
14	INPON	Input Current-Monitor Enable. Drive INPON high to enable IINP.					
15	CCI	Output Current-Regulation Loop Compensation Point. Connect a 0.01µF capacitor from CCS to GND.					
16	CCV	Voltage-Regulation Loop Compensation Point. Connect a $10k\Omega$ resistor in series with a $0.01\mu$ F capacitor to GND.					
17	CCS	Input Current-Regulation Loop Compensation Point. Connect a 0.01µF capacitor from CCS to GND.					
18	GND	Analog Ground					
19	BATT	Battery-Voltage Feedback Input					
20	CSIN	Charge-Current-Sense Negative Input					
21	CSIP	Charge-Current-Sense Positive Input. Connect a current-sense resistor from CSIP to CSIN.					
22	DHIV	High-Side Driver Supply. Connect a 0.1µF capacitor from DHIV to CSSN.					
23 24	DHI SRC	High-Side Power MOSFET Driver Output. Connect to high-side, p-channel MOSFET gate. DC Supply Input Voltage and Connection for Driver for PDS/PDL Switches. Bypass SRC to power ground with					
		a 1µF capacitor.					
25	CSSN	Input Current Sense for Negative Input					
26 27	CSSP PDS	Input Current Sense for Positive Input. Connect a $15m\Omega$ current-sense resistor from CSSP to CSSN. Power-Source PMOS Switch Driver Output. When the adapter is absent, the PDS output is pulled to SRC through an internal $1M\Omega$ resistor.					
28	PDL	System-Load PMOS Switch Driver Output. When the adapter is absent, the PDL output is pulled to ground through an internal $100k\Omega$ resistor.					
29	Backside Paddle	Backside Paddle. Connect the backside paddle to analog ground.					



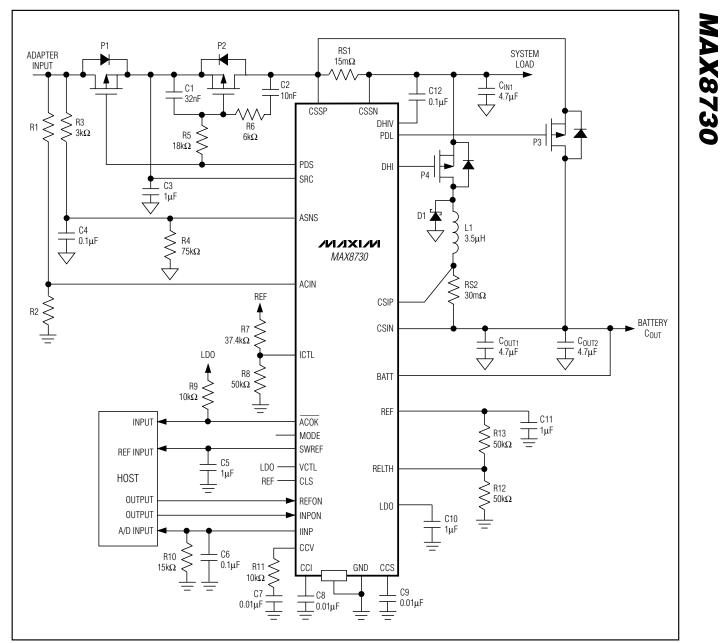


Figure 1. Typical Application Circuit

### \_Detailed Description

The MAX8730 includes all the functions necessary to charge Li+, NiMH, and NiCd batteries. A high-efficiency, step-down, DC-DC converter is used to implement a precision constant-current, constant-voltage charger. The DC-DC converter drives a p-channel MOSFET and uses an external free-wheeling Schottky diode. The charge current and input current-sense amplifiers have low-input offset errors, allowing the use of small-value sense resistors for reduced power dissipation. Figure 2 is the functional diagram.

The MAX8730 features a voltage-regulation loop (CCV) and two current-regulation loops (CCI and CCS). The loops operate independently of each other. The CCV voltage-regulation loop monitors BATT to ensure that its voltage never exceeds the voltage set by VCTL. The CCI battery current-regulation loop monitors current delivered to BATT to ensure that it never exceeds the current limit set by ICTL. The charge-current-regulation loop is in control as long as the battery voltage is below the set point. When the battery voltage reaches its set point, the voltage-regulation loop takes control and maintains the battery voltage at the set point. A third loop (CCS) takes control and reduces the charge current when the adapter current exceeds the input current limit set by CLS.

The ICTL, VCTL, and CLS analog inputs set the charge current, charge voltage, and input-current limit, respectively. For standard applications, default set points for VCTL provide 4.2V per-cell charge voltage. The MODE input selects a 3- or 4-cell mode.

Based on the presence or absence of the AC adapter, the MAX8730 provides an open-drain logic output signal (ACOK) and connects the appropriate source to the system. P-channel MOSFETs controlled from the PDL and PDS select the appropriate power source. The MODE input allows the system to perform a battery relearning cycle. During a relearning cycle, the battery is isolated from the charger and completely discharged through the system load. When the battery reaches 100% depth of discharge, PDL turns off and PDS turns on to connect the adapter to the system and to allow the battery to be recharged to full capacity.

#### **Setting Charge Voltage**

The VCTL input adjusts the battery output voltage,  $V_{BATT}$ . This voltage is calculated by the following equation:

$$V_{BATT} = CELLS \times (4V + \frac{V_{VCTL}}{9})$$

where CELLS is the number of cells selected with the MODE input (see Table 1). Connect MODE to LDO for 4-cell operation. Float the MODE input for 3-cell operation.

The battery-voltage accuracy depends on the absolute value of VCTL, and the accuracy of the resistive voltage-divider that sets VCTL. Calculate the battery voltage accuracy according to the following equation:

$$V_{BATT\_ERROR} = E_0 + 100\% \times \left(\frac{I_{VCTL} \times R_{VCTL}}{36} - 1\right)$$

where E<sub>0</sub> is the worst-case MAX8730 battery voltage error when using 1% resistors (0.83%), I<sub>VCTL</sub> is the VCTL input bias current (4µA), and R<sub>VCTL</sub> is the impedance at VCTL. Connect VCTL to LDO for the default setting of 4.20V/cell with 0.7% accuracy.

Connect MODE to GND to enter relearn mode, which allows the battery to discharge into the system while the adapter is present; see the *Relearn Mode Section*.

### **Table 1. Cell-Count Programming**

CELLS	CELL COUNT
GND	Relearn mode
Float	3
LDO	4

#### **Setting Charge Current**

ICTL sets the maximum voltage across current-sense resistor RS2, which determines the charge current. The full-scale differential voltage between CSIP and CSIN is 135mV (4.5A for RS2 =  $30m\Omega$ ). Set ICTL according to the following equation:

$$V_{\rm ICTL} = I_{\rm CHG} \times RS2 \times \frac{3.6V}{135mV}$$

The input range for ICTL is 0 to 3.6V. To shut down the charger, pull ICTL below 65mV. Choose a current-sense resistor (RS2) to have a sufficient power rating to handle the full-charge current. The current-sense voltage may be reduced to minimize the power dissipation. However, this can degrade accuracy due to the current-sense amplifier's input offset ( $\pm 2$ mV). See the *Typical Operating Characteristics* to estimate the charge-current accuracy at various set points. The charge-current error amplifier (GMI) is compensated at the CCI pin. See the *Compensation* section.



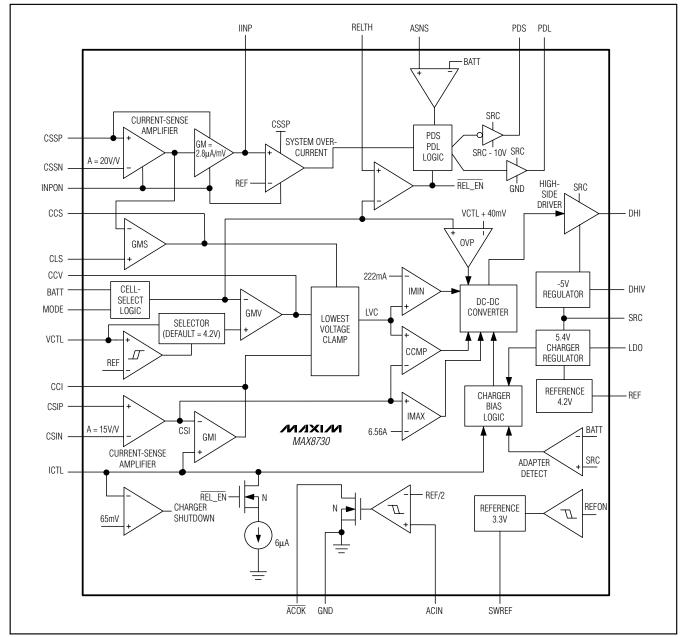


Figure 2. Functional Diagram

**MAX8730** 

The MAX8730 includes a foldback feature, which reduces the Schottky requirement at low battery voltages. See the *Foldback Current Section*.

#### **Setting Input-Current Limit**

The total input current, from a wall adapter or other DC source, is the sum of the system supply current and the current required by the charger. When the input current exceeds the set input current limit, the MAX8730 decreases the charge current to provide priority to system load current. System current normally fluctuates as portions of the system are powered up or put to sleep. The input-current-limit circuit reduces the power requirement of the AC wall adapter, which reduces adapter cost. As the system supply rises, the available charge current drops linearly to zero. Thereafter, the total input current can increase without limit.

The total input current is the sum of the device supply current, the charger input current, and the system load current. The total input current can be estimated as follows:

$$I_{\text{INPUT}} = I_{\text{LOAD}} + \frac{I_{\text{CHARGE}} \times V_{\text{BATTERY}}}{V_{\text{IN}} \times \eta}$$

where  $\eta$  is the efficiency of the DC-DC converter (typically 85% to 95%).

CLS sets the maximum voltage across the currentsense resistor RS1, which determines the input current limit. The full-scale differential voltage between CSSP and CSSN is 75mV (5A for RS1 =  $15m\Omega$ ). Set CLS according to the following equation:

$$V_{CLS} = I_{LIMIT} \times RS1 \times \frac{V_{REF}}{75mV}$$

The input range for CLS is 1.1V to VREF. Choose a current-sense resistor (RS1) to have a sufficient power rating to handle the full system current. The current-sense resistor may be reduced to improve efficiency, but this degrades accuracy due to the current-sense amplifier's input offset (±3mV). See the *Typical Operating Characteristics* to estimate the input current-limit accuracy at various set points. The input current-limit error amplifier (GMS) is compensated at the CCS pin; see the *Compensation* section.

#### **Input-Current Measurement**

IINP monitors the system-input current sensed across CSSP and CSSN. The voltage of IINP is proportional to the input current according to the following equation:

VIINP = IINPUT x RS1 x GIINP x R10

where I<sub>INPUT</sub> is the DC current supplied by the AC adapter, G<sub>IINP</sub> is the transconductance of IINP (2.8 $\mu$ A/mV typ), and R<sub>10</sub> is the resistor connected between IINP and ground. Connect a 0.1 $\mu$ F filter capacitor from IINP to GND to reduce ripple. IINP has a 0 to 4.5V output-voltage range. Connect IINP to GND if it is not used.

The MAX8730 provides a short-circuit latch to protect against system overload or short. The latch is set when VIINP rises above 4.2V, and disconnects the adapter from the system by turning PDS off (PDL does not change). The latch is reset by bringing SRC below UVLO (remove and reinsert the adapter). Choose a filter capacitor that is large enough to provide appropriate debouncing and prevent accidental faults, yet results in a response time that is fast enough to thermally protect the MOSFETs. See the *System Short Circuit* section.

IINP can be used to measure battery-discharge current (see Figure 1) when the adapter is absent. To disable IINP and reduce battery consumption to  $10\mu$ A, drive INPON to low. Charging is disabled when INPON is low, even if the adapter is present.

#### AC-Adapter Detection and Power-Source Selection

The MAX8730 includes a hysteretic comparator that detects the presence of an AC power adapter and automatically selects the appropriate power source. When the adapter is present (VASNS > VBATT - -100mV) the battery is disconnected from the system load with the p-channel (P3) MOSFET. When the adapter is removed (VASNS < VBATT - -270mV), PDS turns off and PDL turns on with a 5µs break-beforemake sequence.

The **ACOK** output can be used to indicate the presence of the adapter. When V<sub>ACIN</sub> > 2.1V and V<sub>ASNS</sub> > V<sub>BATT</sub> - 100mV, **ACOK** becomes low. Connect a 10k $\Omega$  pullup resistor between LDO and **ACOK**. Use a resistive voltage-divider from the adapter's output to the ACIN pin to set the appropriate detection threshold. Since ACIN has a 6V absolute maximum rating, set the adapter threshold according to the following equation:

$$V_{ADAPTER_THRESHOLD} > \frac{V_{ADAPTER_MAX}}{3}$$

#### **Relearn Mode**

The MAX8730 can be programmed to perform a relearn cycle to calibrate the battery's fuel gauge. This cycle consists of isolating the battery from the charger and discharging it through the system load. When the battery



reaches 100% depth of discharge, it is then recharged. Connect MODE to GND to place the MAX8730 in relearn mode. In relearn mode, charging stops, PDS turns off, and PDL turns on.

To utilize relearn mode, there must be two source-connected MOSFETs to prevent the AC adapter from supplying current to the system through the P1's body diode. Connect SRC to the common source node of two MOSFETs.

The system must alert the user before performing a relearn cycle. If the user removes the battery during relearn mode, the MAX8730 detects battery removal and reconnects the AC adapter (PDS turns on and PDL turns off). Battery removal is detected when the battery falls below 5xRELTH.

#### LDO Regulator, REF, and SWREF

An integrated linear regulator (LDO) provides a 5.35V supply derived from SRC, and delivers over 10mA of load current. LDO biases the 4.2V reference (REF) and most of the control circuitry. Bypass LDO to GND with a 1 $\mu$ F ceramic capacitor. An additional standalone 1%, 3.3V linear regulator (SWREF) provides 20mA and can remain on when the adapter is absent. Set REFON low to disable SWREF. Set REFON high for normal operation. SWREF must be enabled to allow charging.

#### **Operating Conditions**

 Adapter present: The adapter is considered to be present when: VSRC > 8V (max)

VASNS > VBATT - 300mV (max)

- Charging: The MAX8730 allows charging when: VSRC - VCSIN > 100mV (typ)
   3 or 4 cells selected (MODE float or high condition) ICTL > 110mV (max)
   INPON is high
- Relearn mode: The MAX8730 enables relearn mode when:

VBATT / 5 > VRELTH MODE is grounded

**DC-DC Converter** 

The MAX8730 employs a step-down DC-DC converter with a p-channel MOSFET switch and an external Schottky diode. The MAX8730 features a constant-current-ripple, current-mode control scheme with cycle-bycycle current limit. For light loads, the MAX8730 operates in discontinuous conduction mode for improved efficiency. The operation of the DC-DC controller is determined by the following four comparators as shown in the functional block diagram in Figure 3: • The IMIN comparator sets the peak inductor current in discontinuous mode. IMIN compares the control signal (LVC) against 100mV (corresponding to 222mA when RS2 =  $30m\Omega$ ). The comparator terminates the switch on-time when IMIN exceeds the threshold.

- The **CCMP** comparator is used for current-mode regulation in continuous conduction mode. CCMP compares LVC against the charging-current feedback signal (CSI). The comparator output is high and the MOSFET on-time is terminated when the CSI voltage is higher than LVC.
- The **IMAX** comparator provides a cycle-by-cycle current limit. IMAX compares CSI to 2.95V (corresponding to 6.56A when RS2 =  $30m\Omega$ ). The comparator output is high and the MOSFET on-time is terminated when the current-sense signal exceeds 6.56A. A new cycle cannot start until the IMAX comparator output goes low.
- The OVP comparator is used to prevent overvoltage at the output due to battery removal. OVP compares BATT against the set voltage; see the Setting Charge Voltage section. When BATT is 20mV x CELLS above the set value, OVP goes high and the MOSFET ontime is terminated.

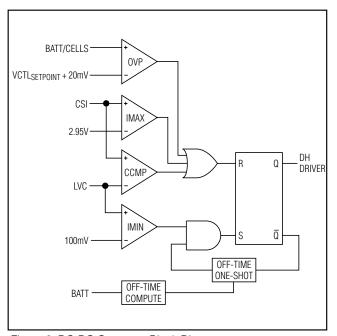


Figure 3. DC-DC Converter Block Diagram



The MAX8730 controls input current (CCS control loop), charge current (CCI control loop), or charge voltage (CCV control loop), depending on the operating condition. The three control loops—CCV, CCI, and CCS—are brought together internally at the lowest voltage clamp (LVC) amplifier. The output of the LVC amplifier is the feedback control signal for the DC-DC controller. The minimum voltage at the CCV, CCI, or CCS appears at the output of the LVC amplifier and clamps the other control loops to within 0.3V above the control point. Clamping the other two control loops close to the lowest control loop ensures fast transition with minimal overshoot when switching between different control loops (see the *Compensation* section).

#### **Continuous-Conduction Mode**

With sufficient charge current, the MAX8730's inductor current never crosses zero, which is defined as continuous-conduction mode. The controller starts a new cycle by turning on the high-side MOSFET. When the charge-current feedback signal (CSI) is greater than the control point (LVC), the CCMP comparator output goes high and the controller initiates the off-time by turning off the MOSFET. The operating frequency is governed by the off-time, which depends upon VBATT.

At the end of the fixed off-time, the controller initiates a new cycle only if the control point (LVC) is greater than 100mV, and the peak charge current is less than the cycle-by-cycle current limit. Restated another way, IMIN must be high, IMAX must be low, and OVP must be low for the controller to initiate a new cycle. If the peak inductor current exceeds the IMAX comparator threshold or the output voltage exceeds the OVP threshold, then the on-time is terminated. The cycle-bycycle current limit protects against overcurrent and short-circuit faults.

The MAX8730 computes the off-time by measuring VBATT:

 $t_{OFF} = 5.6 \mu s / V_{BATT}$ 

for  $V_{BATT} > 4V$ .

The switching frequency in continuous mode varies according to the equation:

$$f = \frac{1}{5.6V \times \mu s \times \left(\frac{1}{V_{SRC} - V_{BATT}} + \frac{1}{V_{BATT}}\right)}$$

#### Discontinuous Conduction

The MAX8730 operates in discontinuous conduction mode at light loads to make sure that the inductor current is always positive. The MAX8730 enters discontinuous conduction mode when the output of the LVC control point falls below 100mV. For RS2 =  $30m\Omega$ , this corresponds to a peak inductor current of 222mA:

$$I_{DIS} = \frac{1}{2} \times \frac{100 \text{mV}}{15 \times \text{RS2}} = 111 \text{mA}$$

The MAX8730 implements slope compensation in discontinuous mode to eliminate multipulsing. This prevents audible noise and minimizes the output ripple.

#### Compensation

The charge-voltage and charge current-regulation loops are compensated separately and independently at the CCV, CCI, and CCS pins.

#### CCV Loop Compensation

The simplified schematic in Figure 4 is sufficient to describe the operation of the MAX8730 when the voltage loop (CCV) is in control. The required compensation network is a pole-zero pair formed with C<sub>CV</sub> and R<sub>CV</sub>. The pole is necessary to roll off the voltage loop's response at low frequency. The zero is necessary to compensate the pole formed by the output capacitor and the load. R<sub>ESR</sub> is the equivalent series resistance (ESR) of the charger output capacitor (C<sub>OUT</sub>). R<sub>L</sub> is the equivalent charger output load, where R<sub>L</sub> =  $\Delta V_{BATT} / \Delta I_{CHG}$ . The equivalent output impedance of the GMV

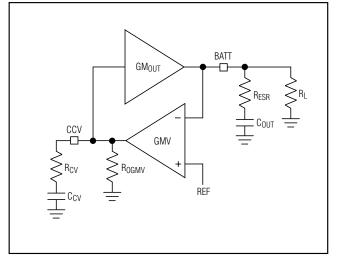


Figure 4. CCV Loop Diagram

amplifier, R<sub>OGMV</sub>, is greater than 10M $\Omega$ . The voltage amplifier transconductance, GMV = 0.125µA/mV for 4 cells and 0.167µA/mV for 3 cells. The DC-DC converter transconductance is dependent upon the charge current-sense resistor RS2:

$$GM_{OUT} = \frac{1}{A_{CSI} \times RS2}$$

where A\_CSI = 15V/V and RS2 = 30m  $\Omega$  in the typical application circuits, so GM\_OUT = 2.22A/V.

The loop transfer function is given by:

$$LTF = GM_{OUT} \times R_L \times GMV \times R_{OGMV} \times \frac{(1 + sC_{OUT} \times R_{ESR})(1 + sC_{CV} \times R_{CV})}{(1 + sC_{CV} \times R_{OGMV})(1 + sC_{OUT} \times R_L)}$$

The poles and zeros of the voltage-loop transfer function are listed from lowest frequency to highest frequency in Table 2.

Near crossover,  $C_{CV}$  is much lower impedance than  $R_{OGMV}$ . Since  $C_{CV}$  is in parallel with  $R_{OGMV}$ ,  $C_{CV}$  dominates the parallel impedance near crossover. Additionally  $R_{CV}$  is much higher impedance than  $C_{CV}$  and dominates the series combination of  $R_{CV}$  and  $C_{CV}$ , so:

$$\frac{\text{R}_{OGMV} \times (1 + \text{s}_{CV} \times \text{R}_{CV})}{(1 + \text{s}_{CV} \times \text{R}_{OGMV})} \cong \text{R}_{CV}$$

 $C_{\text{OUT}}$  is typically much lower impedance than  $R_L$  near crossover so the parallel impedance is mostly capacitive and:

$$\frac{R_L}{(1 + sC_{OUT} \times R_L)} \cong \frac{1}{sC_{OUT}}$$

If R<sub>ESR</sub> is small enough, its associated output zero has a negligible effect near crossover and the loop-transfer function can be simplified as follows:

$$LTF = GM_{OUT} \times \frac{R_{CV}}{sC_{OUT}} G_{MV}$$

Setting the LTF = 1 to solve for the unity-gain frequency yields:

$$f_{CO_{CV}} = GM_{OUT} \times G_{MV} \times \frac{R_{CV}}{2\pi \times C_{OUT}}$$

For stability, choose a crossover frequency lower than 1/5 the switching frequency. For example, choosing a crossover frequency of 45kHz and solving for  $R_{CV}$  using the component values listed in Figure 1 yields  $R_{CV} = 10k\Omega$ :

$$R_{CV} = \frac{2\pi \times C_{OUT} \times f_{CO} CV}{GMV \times GM_{OUT}} \cong 10 k\Omega$$

NAME	EQUATION	DESCRIPTION		
CCV pole	$f_{P_CV} = \frac{1}{2\pi R_{OGMV} \times C_{CV}}$	Lowest frequency pole created by C <sub>CV</sub> and GMV's finite output resistance. Since R <sub>OGMV</sub> is very large and not well controlled, the exact value for the pole frequency is also not well controlled (R <sub>OGMV</sub> > 10M $\Omega$ ).		
CCV zero	$f_{Z_{CV}} = \frac{1}{2\pi R_{CV} \times C_{CV}}$	Voltage-loop compensation zero. If this zero is at the same frequency or lower than the output pole $f_{P_OUT}$ , then the loop-transfer function approximates a single-pole response near the crossover frequency. Choose $C_{CV}$ to place this zero at least 1 decade below crossover to ensure adequate phase margin.		
Output pole	$f_{P_OUT} = \frac{1}{2\pi R_L \times C_{OUT}}$	Output pole formed with the effective load resistance $R_L$ and output capacitance $C_{OUT}$ . $R_L$ influences the DC gain but does not affect the stability of the system or the crossover frequency.		
Output zero	$f_{Z_OUT} = \frac{1}{2\pi R_{ESR} \times C_{OUT}}$	Output ESR Zero. This zero can keep the loop from crossing unity gain if $f_{Z_OUT}$ is less than the desired crossover frequency; therefore, choose a capacitor with an ESR zero greater than the crossover frequency.		

### Table 2. CCV Loop Poles and Zeros

MAX8730

where:

 $V_{BATT} = 16.8V$ GMV = 0.125µA/mV GM<sub>OUT</sub> = 2.22A/V C<sub>OUT</sub> = 10µF

 $f_{OSC}$  = 350kHz (minimum occurs at  $V_{IN}$  = 19V and  $V_{BATT}$  = 16.8V)

 $R_L = 0.2\Omega$ 

fco-cv = 45kHz

To ensure that the compensation zero adequately cancels the output pole, select  $f_{Z_{CV}} \le f_{P_{QUT}}$ :

CCV ≥ (RL / RCV) COUT

C<sub>CV</sub> ≥ 200pF

Figure 5 shows the Bode plot of the voltage-loop frequency response using the values calculated above.

#### **CCI Loop Compensation**

The simplified schematic in Figure 6 is sufficient to describe the operation of the MAX8730 when the battery current loop (CCI) is in control. Since the output capacitor's impedance has little effect on the response of the current loop, only a simple single pole is required to compensate this loop. A<sub>CSI</sub> is the internal gain of the current-sense amplifier. RS2 is the charge-current-sense resistor (30m $\Omega$ ). R<sub>OGMI</sub> is the equivalent output impedance of the GMI amplifier, which is greater than 10M $\Omega$ . GMI is the charge-current amplifier transconductance = 1µA/mV. GM<sub>OUT</sub> is the DC-DC converter transconductance = 2.22A/V.

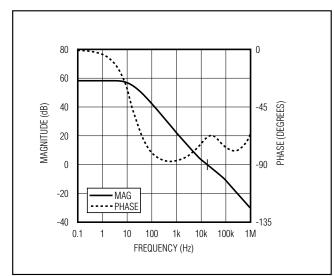


Figure 5. CCV Loop Response

The loop transfer function is given by:

$$\text{LTF} = \text{GM}_{\text{OUT}} \times \text{A}_{\text{CSI}} \times \text{RS} \times \text{GMI} \frac{\text{R}_{\text{OGMI}}}{1 + \text{sR}_{\text{OGMI}} \times \text{C}_{\text{CI}}}$$

that describes a single-pole system. Since:

$$GM_{OUT} = \frac{1}{A_{CSI} \times RS}$$

the loop-transfer function simplifies to:

$$LTF = GMI \frac{R_{OGMI}}{1 + sR_{OGMI} \times C_{CI}}$$

The crossover frequency is given by:

$$f_{CO_CI} = \frac{GMI}{2\pi C_{CI}}$$

For stability, choose a crossover frequency lower than 1/10 of the switching frequency:

$$C_{CI} > \frac{10 \times GMI}{2\pi \times C_{CI}} = 4nF$$

Values for C<sub>CI</sub> greater than 10 times the minimum value may slow down the current-loop response. Choosing  $C_{CI} = 10$ nF yields a crossover frequency of 15.9kHz. Figure 7 shows the Bode plot of the current-loop frequency response using the values calculated above.

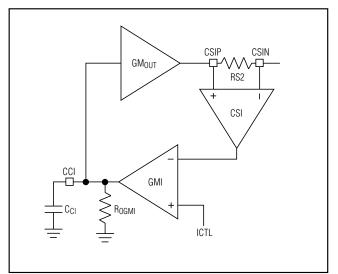


Figure 6. CCI Loop Diagram

#### CCS Loop Compensation

The simplified schematic in Figure 8 is sufficient to describe the operation of the MAX8730 when the input current-limit loop (CCS) is in control. Since the output capacitor's impedance has little effect on the response of the input current-limit loop, only a single pole is required to compensate this loop. ACSS is the internal gain of the current-sense amplifier, RS1 = 10m $\Omega$  in the typical application circuits. ROGMS is the equivalent output impedance of the GMS amplifier, which is greater than 10M $\Omega$ . GMS is the charge-current amplifier transconductance = 1µA/mV. GMIN is the DC-DC converter's input-referred transconductance = GM<sub>OUT</sub>/D = 2.22A/V/D.

The loop-transfer function is given by:

 $LTF = GM_{IN} \times A_{CSS} \times RSI \times GMS \frac{R_{OGMS}}{1 + SR_{OGMS} \times C_{CS}}$ 

Since  $GM_{IN} = \frac{1}{A_{CSS} \times RS2}$ 

the loop-transfer function simplifies to:

$$LTF = GMS \frac{R_{OGMS}}{1 + SR_{OGMS} \times C_{CS}} \times RS1/RS2$$

The crossover frequency is given by:

$$f_{CO_CS} = \frac{GMS}{2\pi C_{CS}} \times \frac{V_{IN_MAX}}{V_{BATT_MIN}}$$

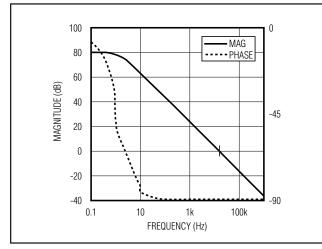


Figure 7. CCI Loop Response

For stability, choose a crossover frequency lower than 1/10 of the switching frequency:

$$C_{CS} = 5 \times \frac{GMS}{2\pi f_{OSC}} \times \frac{V_{IN}MAX}{V_{BATT}MIN}$$

Values for CCS greater than 10 times the minimum value may slow down the current-loop response excessively. Figure 9 shows the Bode plot of the input current-limit-loop frequency response using the values calculated above.

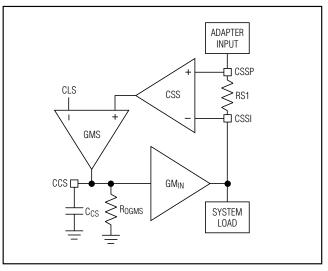


Figure 8. CCI Loop Diagram

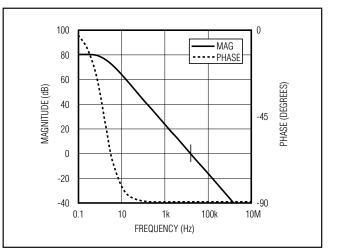


Figure 9. CCS Loop Response

#### **MOSFET Drivers**

The DHI output is optimized for driving moderate-sized power MOSFETs. This is consistent with the variable duty factor that occurs in the notebook computer environment where the battery voltage changes over a wide range. DHI swings from SRC to DHIV and has a typical impedance of  $1\Omega$  sourcing and  $4\Omega$  sinking.

### **Design Procedure**

#### **MOSFET Selection**

Choose the p-channel MOSFETs according to the maximum required charge current. The MOSFET (P4) must be able to dissipate the resistive losses plus the switching losses at both VSRC(MIN) and VSRC(MAX).

The worst-case resistive power losses occur at the maximum battery voltage. Calculate the resistive losses according to the following equation:

$$PD_{Resistance} = \frac{V_{BATT}}{V_{SRC}} \times I_{CHG}^2 \times R_{DS(ON)}$$

Calculate the switching losses according to the following equation:

$$PD_{SWITCHING} = \frac{1}{2} \times \frac{\left(\frac{2 \times Q_{G}}{I_{GATE}} \times V_{SRC}(MAX) \times I_{CHG}\right) + \left(V_{SRC}(MAX)^{2} \times C_{RSS}\right)}{f}$$

where  $\mathsf{C}_{\mathsf{RSS}}$  is the reverse transfer capacitance of the MOSFET, and  $\mathsf{I}_{\mathsf{GATE}}$  is the peak gate-drive source/sink current.

These calculations provide an estimate and are not a substitute for breadboard evaluation, preferably including a verification using a thermocoupler mounted on the MOSFET.

Generally, a small MOSFET is desired to reduce switching losses at V<sub>BATT</sub> = V<sub>SRC</sub> / 2. This requires a tradeoff between gate charge and resistance. Switching losses in the MOSFET can become significant when the maximum AC adapter voltage is applied. If the MOSFET that was chosen for adequate R<sub>DS(ON)</sub> at low supply voltages becomes hot when subjected to V<sub>SRC(MAX)</sub>, then choose a MOSFET with lower gate charge. The actual switching losses that can vary due to factors include the internal gate resistance, threshold voltage, source inductance, and PC board layout characteristics.

See Table 3 for suggestions about MOSFET selection.

#### **Schottky Selection**

The Schottky diode conducts the inductor current during the off-time. Choose a Schottky diode with the appropriate thermal resistance to guarantee that it does not overheat:

$$\theta_{JA} < \frac{T_{J\_MAX} - T_{A\_MAX}}{V_{F} \times I_{CHG} \times \left(1 - \frac{V_{BATT\_MIN}}{V_{SRC\_MAX}}\right)}$$

CHARGE CURRENT (A)	MOSFET	PIN-PACKAGE	MAX		RθJA	Tury (°C)
CHANGE CONNENT (A)			Q <sub>G</sub> (nC)	<b>R</b> <sub>DSON</sub> (m $\Omega$ )	(°/W)	T <sub>MAX</sub> (°C)
3	Si3457DV	6-SOT23	8	75	78	+150
2.5	FDC658P	6-SOT23	12	75	78	+150
3.5	FDS9435A	8-SO	14	80	50	+175
3.5	NDS9435A	8-SO	14	80	50	+175
4	FDS4435	8-SO	24	35	50	+175
4	FDS6685	8-SO	24	35	50	+175
4.5	FDS6675A	8-SO	34	19	50	+175



where  $\theta_{JA}$  is the thermal resistance of the package (in °C/W),  $T_{J\_MAX}$  is the maximum junction temperature of the diode,  $T_{A\_MAX}$  is the maximum ambient temperature of the system, and  $V_F$  is the forward voltage of the Schottky diode.

The Schottky size and cost can be reduced by utilizing the MAX8730 foldback function. See the *Foldback Current* section for more information.

Select the Schottky diode to minimize the battery leakage current when the charger is shut down.

#### Inductor Selection

The MAX8730 uses a fixed inductor current ripple architecture to minimize the inductance. The charge current, ripple, and operating frequency (off-time) affects inductor selection. For a good trade-off of inductor size and efficiency, choose the inductance according to the following equation:

$$L = \frac{k_{OFF}}{0.4 \times l_{CHG}}$$

where  $k_{OFF}$  is the off-time constant (5.6V x µs typically).

Higher inductance values decrease the RMS current at the cost of inductor size.

Inductor L1 must have a saturation current rating of at least the maximum charge current plus 1/2 of the ripple current ( $\Delta I_L$ ):

$$I_{SAT} = I_{CHG} + (1/2) \Delta I_{L}$$

Table 4. Recommended Inductors

The ripple current is determined by:

$$\Delta I_{L} = \frac{k_{OFF}}{L}$$

The ripple current is only dependent on inductance value and is independent of input and output voltage. See the Ripple Current vs. VBATT graph in the *Typical Operating Characteristics*.

See Table 4 for suggestions about inductor selection.

#### **Input Capacitor Selection**

The input capacitor must meet the ripple current requirement (I<sub>RMS</sub>) imposed by the switching currents. Ceramic capacitors are preferred due to their resilience to power-up surge currents:

$$I_{RMS} = I_{CHG} \left( \frac{\sqrt{V_{BATT} (V_{SRC} - V_{BATT})}}{V_{SRC}} \right) = \frac{I_{CHG}}{2}$$

at 50% duty cycle.

The input capacitors should be sized so that the temperature rise due to ripple current in continuous conduction does not exceed about 10°C. The maximum ripple current occurs at 50% duty factor or V<sub>SRC</sub> = 2 x V<sub>BATT</sub>, which equates to 0.5 x I<sub>CHG</sub>. If the application of interest does not achieve the maximum value, size the input capacitors according to the worst-case conditions. See Table 5 for suggestions about input capacitor selection.

APPLICATION (A)	INDUCTOR	SIZE (mm)	L (µH)	I <sub>SAT</sub> (A)	R <sub>L</sub> (mΩ)
2.5	CDRH6D38	8.3 x 8.3 x 3	3.3	3.5	20
2.5	CDRH8D28	7 x 7 x 4	4.7	3.4	24.7
3.5	CDRH8D38	8.3 x 8.3 x 4	3.5	4.4	24

#### Table 5. Recommended Input Capacitors

APPLICATION (A)	INPUT CAPACITOR	CAPACITANCE( µF)	VOLTS (V)	RMS AT 10°C (A)
< 3	GMK316F47S2G	4.7	35	1.8
< 4	GMK325F106ZH	4.7	35	2.4
< 4	TMK325BJ475MN	10	25	2.5